

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10625737
<b>Filing Date:</b>	24-Jul-2003
<b>Title of Invention:</b>	SEMICONDUCTOR DEVICE MANUFACTURING METHOD, HEAT TREATMENT APPARATUS, AND HEAT TREATMENT METHOD
<b>First Named Inventor/Applicant Name:</b>	Koji Dairiki
<b>Filer:</b>	Eric J. Robinson/Sue Ann Carr
<b>Attorney Docket Number:</b>	0756-7176

Filed as Large Entity

### Utility under 35 USC 111(a) Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
Utility Appl issue fee	1501	1	1510	1510
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Printed copy of patent - no color	8001	3	3	9
Total in USD (\$)				1819